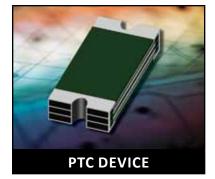
POLYMER PTC DEVICE



DESCRIPTION

Surface mount PTC devices are the preferred over-current protection method for computer, consumer electronic, portable electronics and automotive applications. These devices are suitable for automated assembly and are designed to save on board space.

FEATURES

- Over-Current Protection
- RoHS & REACH Compliant
- Halogen-Free Material
- UL Recognized

MECHANICAL CHARACTERISTICS

- Surface Mount Device: Size 1812
- Approximate Weight: 0.0476 grams
- Lead-Free
- 12mm Tape and Reel Per EIA Standard 481

APPLICATIONS

- Motherboard USB & IEEE 1394 Protection
- USB & HDMI Port Protection Set-Top Boxes, Game Consoles
- Battery PCM
- Mobile Internet Device (MID)
- IC VCC Protection
- Optical Electronics
- Security Systems
- Industrial Controls

	ELECTRICAL SPECIFICATIONS										
PART NUMBER	MARKING CODE	MAXIMUM HOLDING CURRENT (Note 1)	MINIMUM TRIP CURRENT (Note 2)	MAXIMUM INTERRUPT VOLTAGE (Note 3) V _{MAX}	CURRENT (Note 4)	(Note 5) T	TYPICAL POWER DISSIPATION (Note 6) P	MINIMUM RESISTANCE (Note 7) R _{MIN}	MAXIMUM RESISTANCE (Note 8) R _{MAX}		
		AMPS	AMPS			AMPS @ Secs	WATTS	OHMS	OHMS		
PMPS260C-1812	260	2.60	5.00	8	100	8.00A @ 4.00s	0.8	0.010	0.040		

NOTES

1. The maximum current at which the device will not trip at 25°C in still air.

2. The minimum current at which the device will always trip at 25 $^{\circ}\mathrm{C}$ in still air.

3. The maximum interrupt voltage the device can withstand without damage at the rated current.

4. The maximum fault current the device can withstand without damage at the rated voltage.

5. The maximum time to trip at the assigned current.

6. The typical amount of power dissipated by the device when in state air environment.

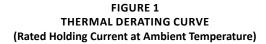
The minimum device resistance at 25°C prior to tripping.

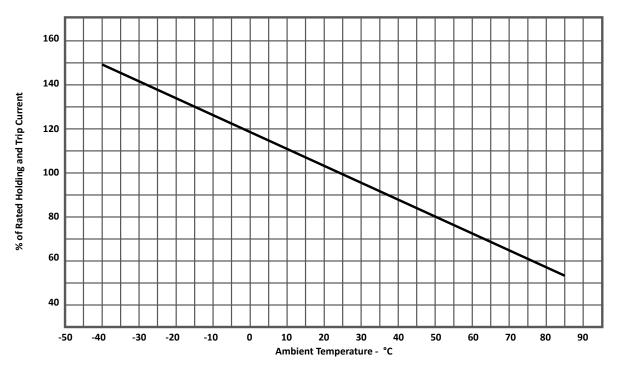
8. The maximum device resistance at 25°C measured one hour post reflow.

TYPICAL DEVICE CHARACTERISTICS

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TEST PROCEDURES AND REQUIREMENTS									
TEST CONDITIONS ACCEPTANCE CRITERIA									
Resistance	In Still Air @ 25°C	R _{min} <= R <= R _{max}							
Time to Trip (T _{Trip})	Specified Current V _{max} - In Still Air @ 25°C	T <= Max Time to Trip							
Holding Current (I _H)	30 Minutes at I _H - In Still Air @ 25°C	No Trip							
Trip Life Cycle	V _{max} , I _{max} , 100 Cycles - In Still Air @ 25°C	No Arcing or Burning							
Trip Endurance	V _{max} , 60 Minutes - In Still Air @ 25°C	No Arcing or Burning							





MAXIMUM AMBIENT OPERATING TEMPERATURES - °C											
BASE PART NUMBER	ISE PART NUMBER										
DMD52506 1912	T (°C)	-40	-20	0	25	40	50	60	70	85	
PMPS260C-1812	l _{H(Max)}	3.40	3.16	3.00	2.60	2.30	2.15	2.00	1.85	1.63	

TYPICAL DEVICE CHARACTERISTICS

SOLDERING PARAMETERS								
PROFILE FEATURES	PB-FREE ASSEMBLY							
Average Ramp-Up Rate - Tsmin to Tp	3°C/Second Max							
Preheat - Temperature Min (Tsmin) - Temperature Max (Tsmax) - Time (Tsmin to Tsmax)	150°C 200°C 60-180 Seconds							
Time Maintained Above: - Temperature (Tm) - Time (tm)	217°C 60-150 Seconds							
Peak Temperature (Tp)	260°C							
Time within 5°C of Tp (tp)	20-40 Seconds							
Ramp-Down Rate	6°C/Seconds Max							
Time 25°C to Tp	8 Minutes Max							

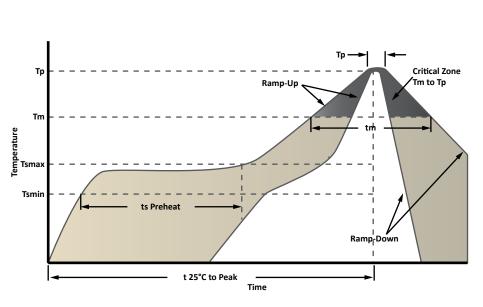
1. All temperatures refer to topside of the package, measured on the package body surface.

2. Recommended reflow methods: IR, Vapor Phase, Hot Air Oven.

3. Devices are not designed to be wave soldered to the bottom side of the board.

4. Devices can be cleaned using standard industry methods and solvents.

5. If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.



NOTICES

The devices are intended for protection against overcurrent or overtemperature fault conditions and should not be used when repeated fault conditions are anticipated. Operation beyond maximum ratings or improper use may result in device damage and possible arcing and flame.

WARNING

Operation beyond the maximum ratings or improper use may result in device damage and possible electrical arcing and flame. Polymeric thermistors operate by thermal expansion of the conductive polymer. If devices are placed under pressure or installed in space that would prevent thermal expansion, they may not properly protect against fault conditions. Designs must be selected in such a manner that adequate space is maintained over the life of the product.

Twisting, bending, or placing the Polymeric thermistors in tension will decrease the ability of the device to protect against electrical faults. No residual force should remain on the device after installation. Mechanical damage to Polymeric thermistors chip may affect device performance and should be avoided.

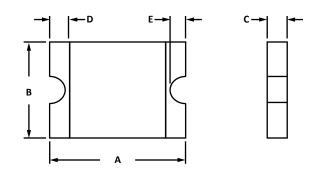
Chemical contamination of Polymeric thermistors should be avoided. Certain greases, solvents, hydraulic fluids, fuels, industrial cleaning agents, volatile components of adhesives, silicones and electrolytes can have an adverse effect on the device performance.

Environmental conditions must not harm the thermistors. Use thermistors only in normal atmospheric conditions. Avoid use in deoxidizing gases, corrosive agents, humid or salty conditions. Contact with any liquids and solvents should be prevented. Device performance can be impacted negatively if devices are handled in a manner inconsistent with recommended electronic, thermal and mechanical procedures for electronic components.

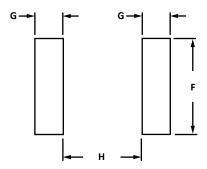
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PACKAGE OUTLINE AND PAD LAYOUT INFORMATION

	OUTLINE DIMENSIONS										
DIM	MILLIN	IETERS	INCHES								
DIN	MIN	MAX	MIN	MAX							
А	4.37	4.73	0.17	0.19							
В	3.07	3.41	0.12 0.13								
С	0.9	90	0.035								
D	0.30	1.20	0.02	0.05							
E 0.15 0.65 0.006 0.026											
	NOTES 1. Dimensions are exclusive of mold flash and metal burrs.										



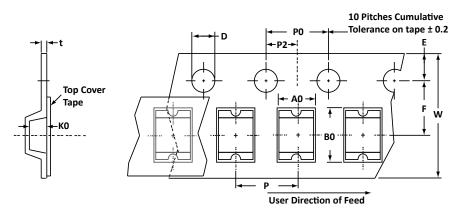
OUTLINE DIMENSIONS									
	MILLIMETERS	INCHES							
DIM	NOM	NOM							
F	1.80	0.07							
G	1.00	0.04							
Н	1.80	0.07							
	NOTES 1. Dimensions are exclusive of mold flash and metal burrs.								



PMPS260C-1812

TAPE AND REEL

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SPECIFICATIONS												
REEL DIA.	TAPE WIDTH	A0	В0	ко	D	E	F	w	PO	P2	Р	t
178mm (7")	12mm	3.50 ± 0.10	4.90 ± 0.10	0.80 ± 0.10	1.55 ± 0.05	1.75 ± 0.10	5.50 ± 0.10	12.00 ± 0.30	4.00 ± 0.10	2.00 ± 0.05	4.00 ± 0.10	0.25±0.05
NOTES 1. Dimensions are in millimeters. 2. Surface mount product is taged and realed in accordance with EU-491												

2. Surface mount product is taped and reeled in accordance with EIA-481.

3. Suffix - T7 = 7" Reel - 2,000 pieces per 8mm tape.

4. Marking on Part - marking code.

ORDERING INFORMATION									
BASE PART NUMBER LEADFREE SUFFIX TAPE SUFFIX QTY/REEL REEL SIZE TUBE QTY									
PMPS260C-1812	N/A	-T7	2,000	7″	N/A				
This device is only available in a Lead-Free configuration. The ambient temperature for storage is -40°C~40°C, with a maximum relative humidity recommended at 70%RH.									

COMPANY INFORMATION

COMPANY PROFILE

In business more than 20 years, ProTek Devices[™] is a privately held semiconductor company. The company offers a product line of overvoltage protection and overcurrent protection components. These include transient voltage suppressor array (TVS arrays) avalanche breakdown diode, steering diode TVS array and electronics SMD chip fuses. These components deliver circuit protection in electronic systems from numerous overvoltage and overcurrent events. They include lightning; electrostatic discharge (ESD); nuclear electromagnetic pulses (NEMP); inductive switching; and electromagnetic interference (EMI) / radio frequency interference (RFI). ProTek Devices also offers high performance interface and linear products. They include analog switches; multiplexers; LED drivers; LED wafer die for ESD protection; audio control ICs; RF and related high frequency products.

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